

**LTD-OA1000**  
**User Manual**



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## **Summary**

This Document describes the technical specification of module which includes the interface, the mechanical specification, and the electrical characteristics.

## **1. Product Introduction**

This is a mobile communication module that supports various interfaces like USB and UART.

The module is designed for the automotive industry.

It also supports carrier aggregation as per 3GPP, which is dependent on carrier and chipset support.

## 1.2 Key Features

Feature	Implementation
General	
Frequency bands	Please refer to the RF Specification
Output power	Class 3 (20.3~25.7dBm) for WCDMA & LTE
Power supply	Operating conditions : 3.9V < VPH_PWR_CH1 < 4.1V (Typ. 4.0V)
4G/5G DCDC	Absolute maximum ratings : 0V < VPH_PWR < +5.0V
Power Supply PMIC	Operating conditions : 3.9V < VPH_PWR_PMIC < 4.1V (Typ. 4.0V) Absolute maximum ratings : 0V < VPH_PWR < +5.0V
Operating temperature	Normal operation : -20°C to +70°C (Class A) Extended operation : -40~-20°C, +70~+85°C (Class B)
Physical	Dimensions : 50mm x 50mm x 3.5mm Weight : Max 18.0 grams
RoHS	All hardware components fully compliant with EU RoHS Directive
Interfaces	
Module Interfaces	Surface mount device with solderable connection pads (SMT application interface).
Antenna	50 Ohms. LTE main antenna, LTE Diversity/MIMO antenna
USB	USB 3.0 SuperSpeed and high-speed(for backward compatibility)
UIM interface	Support two ports. including dual-voltage options
Memory	8Gb NAND Flash / 8Gb LPDDR4x SDRAM

## 1.3 Environmental Specifications

The environmental specification for both operating and storage temperature of modules are defined in the below table.

Parameter	Temperature Range	Operating Class
Ambient Operating Temperature	From -20°C to +70°C	Class A
	From -40~-20°C, +70~+85°C	Class B
Ambient Storage Temperature	From -40°C to +85°C	
Ambient Humidity	95% or less	

Table 1.0 : Environmental Specifications

Note.

: The customer must design the heat dissipation not to exceed the junction temperature of the main components at 85°C.(Refer to Design Guide for junction temperature)

Class A is defined as the operating temperature ranges that the device:

- Shall exhibit normal function during and after environmental exposure.
- Shall meet the minimum requirements of 3GPP or appropriate wireless standards.

Class B is defined as the operating temperature ranges that the device:

- Shall remain fully functional during and after environmental exposure
- Shall exhibit the ability to establish a voice, SMS or DATA call (emergency call) at all times even when one or more environmental constraint exceeds the specified tolerance.
- Unless otherwise stated, full performance should return to normal after the excessive constraint(s) have been removed.

## 1.4 Mechanical Specifications

This module is a Land Grid Array (LGA) form factor device that does not have any System or RF connectors. All electrical and mechanical connections are made via the 581 pads LGA on the underside of the PCB.

Parameter	Nominal	Tolerance	Units
Overall Dimension <sup>1)</sup>	50.0 x 50.0	±0.15	mm
Overall Module Height (Excluding ball thickness)	3.5	±0.2	mm
Final coplanarity (including warpage)	-	230	mm
Weight (Max)	17		g

Table 1.1 : Module Dimensions

- Note.

: <sup>1)</sup>Overall Dimension refers to the size excluding the routing area.

There should be no other components within 500um of the product outer edge.

## 1.5 LGA moisture sensitivity level

- MSL 3 Level (Floor Life Time : 168Hrs. / Condition : ≤30°C, 60% RH)

- Standard : IPC / JEDEC J-STD-020C

## 1.6. Communication Specification

### 1.6.1. GSM

#### 1) Receiver

- Frequency : 869~894 MHz (GSM850)
- Modulation method : GMSK, 8PSK
- reception sensitivity :  $\leq -104\text{dBm}$ (class II (RBER) $\leq 2.4\%$ ) (GSM850)  
 $\leq -102\text{dBm}$ (class II (RBER) $\leq 2.4\%$ ) (DCS1800)  
3GPP TS 45.005 Table 6.2.1a

#### 2) Transmitter

- Frequency : 824~849 MHz (GSM850)
- Modulation method : GMSK, 8PSK
- Maximum RF Output : 31dBm~35dBm (GSM850)

### 1.6.2. WCDMA

#### 1) Receiver

- Bandwidth : 5MHz
- Frequency : B5(869~894 MHz)
- RF to Baseband Direct conversion (Zero IF)
- Modulation method : QPSK and 16QAM
- reception sensitivity : B5 $\leq -104.0\text{dBm}$   
(BER= $<0.1\%$ ) 3GPP TS 34.121-1 Table 6.2.2

#### 2) Transmitter

- Frequency : B5(824~849 MHz)
- Maximum RF Output : Power class 3, 20.3dBm ~ 25.7dBm
- Modulation method : QPSK
- Baseband to RF Direct conversion (Zero IF)

### 1.6.3. LTE

#### 1) Receiver

- Bandwidth : 3GPP TS 36.521-1 Table 5.4.2.1-1
- Frequency : B41(2496~2690 MHz) RF to Baseband Direct conversion (Zero IF)
- Modulation method : QPSK, 16QAM and 64QAM
- reception sensitivity : B41 ( $\leq -94.3\text{dBm}$ )
  - @QPSK, Channel bandwidth=10MHz 3GPP TS 36.521-1 Table 7.3.5-1

#### 2) Transmitter

- Frequency: B41(2496~2690 MHz)
- Maximum RF Output: Power class 3,  $20.3\text{dBm} \sim 25.7\text{dBm}$
- Modulation method: QPSK and 16QAM
- Baseband to RF Direct conversion (Zero IF)

## **Integration Guide**

Changes or modifications to this equipment may cause harmful interference unless the modifications are expressly approved in the instruction manual. Users may lose the authority to operate this equipment if an unauthorized change or codification is made.

Note:

If this module is intended for use in a portable device, additional testing will be required to satisfy the RF exposure and SAR requirements of FCC Part 2.1093 and RSS-102.

# OEM Manual

## **The List of applicable FCC rules**

FCC : Part 22, Part 27

## **Summarize the specific operational use conditions**

The module is designed for vehicle only, and has to be tested additional if insert in other host.

## **Limited module procedures**

N/A

## **Trace antenna designs**

N/A

## **RF exposure considerations**

RF Exposure evaluation was performed with very specific installation condition at 20 cm. Any other installation condition may require additional test and permissive change procedure.

## **Antennas**

Dipole Antenna is used for testing, with unique antenna conector. The maximum antenna gain including cable loss in a mobile-only exposure condition must not exceed the values listed in the following table.

Band	Antenna Gain (dBi)
GSM 850	2.18
WCDMA 5	2.18
LTE Band 41	3.97

## **Label and compliance information**

To satisfy the labeling requirements, the following text must appear on the exterior of the end product.

Contains FCC ID : YZP-OA1000

## **Information on test modes and additional testing requirements**

If additional module is inserted in the host, test modes should take into consideration different operational conditions for a standalone modular transmitter in a host.

## **Additional testing, Part 15 Subpart B disclaimer**

According to § 15.103 Exempted devices, (a), this module is exempted due to utilized exclusively in transportation vehicle.

# User Manual Notice

## FCC

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

This module complies with FCC radiation exposure limits set forth for uncontrolled environments. This module must be installed and operated with minimum distance of 20 cm between the radiating element and the user. This module must not be co-located with any other transmitters or antennas.